Your Submission EPJB-D-21-00507R1 - [EMID:13bd6d1e03ab747e]

1 message

Sandrine Karpe <em@editorialmanager.com>
Reply-To: Sandrine Karpe <epjb@edpsciences.org>
To: Iwan Halim Sahputra <iwanh@petra.ac.id>

Tue, Nov 16, 2021 at 1:09 PM

Dear Dr. Sahputra,

We are pleased to inform you that your manuscript, "Temperature and Indenter Radius Effects on Mechanical Properties of Copper during Nanoindentation: A Molecular Dynamic Simulation Study", has been accepted for publication in The European Physical Journal B.

You will receive an e-mail in due course regarding the production process.

You have the possibility to suggest a nice figure related to the content of your manuscript (but not necessarily one of the figures of the manuscript) as a candidate for the cover. This would give additional visibility to your article.

When you submit your cover image proposal, we ask you to clearly label the file as "cover_proposal_name" and submit your cover image (for which you have the copyright and provide us with permission to use in this capacity) and caption, within one week after acceptance of your article.

Please note that the Editors-in-Chief will have the final say over the choice of image selected to appear on the printed cover of the journal, should they receive more than one cover image proposal from the authors of the issue that will be featuring your work. The Editors-in-Chief will look at both the image appearance (nice colour, design, etc...) and the significance of the results presented there.

Please send your proposal to Sandrine Karpe at epib@edpsciences.org.

Please remember to quote the manuscript number, EPJB-D-21-00507R1, whenever inquiring about your manuscript.

With kind regards, Riccardo Rurali Associate Editor The European Physical Journal B

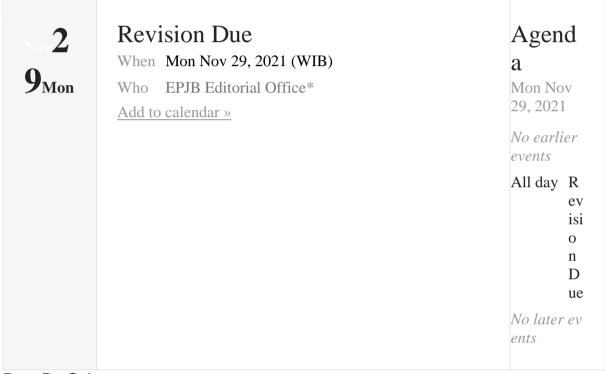
Major Revisions requested EPJB-D-21-00507



Sandrine Karpe <em@editorialmanager.com>

Tue, Nov 2, 2021, 2:56 AM

to me



Dear Dr. Sahputra,

We have received the reports from our advisors on your manuscript, "Temperature and Indenter Radius Effects on Mechanical Properties of Copper during Nanoindentation: A Molecular Dynamic Simulation Study", which you submitted to The European Physical Journal B.

Based on the advice received, I have decided that your manuscript could be reconsidered for publication should you be prepared to incorporate major revisions. When preparing your revised manuscript, you are asked to carefully consider the reviewer comments which can be found below, and submit a list of responses to the comments. You are kindly requested to also check the website for possible reviewer attachment(s).

While submitting, please check the filled in author data carefully and update them if applicable - they need to be complete and correct in order for the revision to be processed further.

In order to submit your revised manuscript, please access the following web site:

https://www.editorialmanager.com/epjb/

Your username is: Iwan H.Sahputra If you forgot your password, you can click the 'Send Login Details' link on the EM Login page.

We look forward to receiving your revised manuscript before 29 Nov 2021. In order to add the due date to your electronic calendar, please open the attached file.

With kind regards, Riccardo Rurali Associate Editor The European Physical Journal B